Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	839	(257/691).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/01/06 12:18
S2	407	((257/691).CCLS.) and via	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/03 13:26
S3	372	((257/691).CCLS.) and via	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/03 14:44
S4	4	("4686492" "5606196" "5677570" "6208023").PN.	USPAT	OR	ON	2003/01/03 13:27
S5	12	"4686492".URPN.	USPAT	OR	ON	2003/01/03 13:28
S6	1	"20020084516".pn.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/03 1.4:52
S7	2	"20020084516".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 10:56
S8	2	"5973554".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 12:14
S9	0	resistnce with less with than with "5"\$ohms	USPAT	OR	ON	2003/01/06 12:15
S10	0	resistance with less with than with "5"\$ohms	USPAT	OR	ON	2003/01/06 12:16
S11	0	resistance with less with than with "5"\$ohm	USPAT	OR	ON	2003/01/06 12:16
S12	0	resistance with less with than with ohm	USPAT	OR	ON	2003/01/06 12:16
S13	0	resistance with less with than with line	USPAT	OR	ON	2003/01/06 12:16
S14	0	resistance with less with than with line	USPAT	OR	ON	2003/01/06 12:17
S15	0	resistance with less with than with line	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 12:17

S16	839	(257/691).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/01/06 12:19
S17	0	resistance with less with than with ohm	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/13 21:39
S18	35324	resistance with ohm	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 12:19
S19	185	resistance with ohm with line with low	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OŖ	ON	2003/01/06 12:20
S20	7589	sheet with resistance with low	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 12:24
S21	450	sheet with resistance with low with values	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 12:26
S22	40	(sheet with resistance with low) and sheet with resistance with low with omega	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:02
S23	4	("5973554" "5468993").pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:22
S24	1	gold with film with increase with wettability	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:25
S25	37	gold with film with wettability	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:29

S26	682	film with (increase improve)with wettability	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:31
S27	21	(film with (increase improve)with wettability) and pattern with film with (increase improve)with wettability	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:33
S28	682	film with (increase improve)with wettability	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:34
S29	67	(film with (increase improve)with wettability) and film with (gold or au)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:39
S30	0	auminum with film with (gold or au)with wettability	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:40
S31	0	aluminum with film with (gold or au)with wettability	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:41
S32	119	aluminum with film with wettability	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:49
S33	1	aluminum with electrode with wettability with wire	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:50
S34	0	aluminum with electrode with cotaing with wire	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:50
S35	0	aluminum with electrode with cotating with wire	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:50
S36	123	aluminum with electrode with coating with wire	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:54
S37	0	aluminum with electrode same gold with wire same wettability	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:56
S38	0	electrode with aluminum with gold with wettability	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 13:57

S39	9	aluminum with gold with wettability	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 14:00
S40	2	"5973554".pn.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 14:01
S41	0	bonding with wire with aluminum with electrode with wettabilility	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 14:02
S42	0	bonding with wire with aluminum with electrode with wettability	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 14:02
S43	0	bonding with wire with (alumlinum al aluminun) with electrode with wettability	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 14:03
S44	0	bonding with wire with (aluminum al aluminun) with electrode with wettability	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 14:03
S45	24	bonding with wire with (aluminum al aluminun) with electrode with (improve increase)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 15:59
S46	2	"6097086".pn.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 16:45
S47	57	("3326726" "3337838" "3366915" "3444506" "3848221" "4274700" "4487463" "4530002" "4572604" "4616406" "4654472" "4655526" "4667220" "4698663" "4724472" "4734042" "4897055" "4943846" "4959750" "4975066" "4997376" "5015207" "5037311" "5071363" "5081563" "5106461" "5110760" "5117069" "5123164" "5137456" "5200357" "5281151" "5309024" "5326936" "5330372" "5334279" "5342999" "53351393" "5371404" "5576825" "5536362" "5569955" "5575688" "5578870" "5593322" "5611884" "5634821" "5639247" "5641309" "5645433" "5646442" "5702255" "5824950" "5854512").PN.	USPAT	OR	ON	2003/01/06 15:59

S48	16	("5237202" "5241133" "5285352" "5334857" "5397917" "5433822" "5455456" "5508556" "5539153" "5551148" "5552635" "5569955" "5592025" "5598321" "5635671" "5689091").PN.	USPAT	OR	ON	2003/01/06 15:59
S49	34	("3337838" "3366915" "3444506" "3848221" "4274700" "4487463" "4572604" "4616406" "4654472" "4655526" "4698663" "4734042" "4897055" "4943846" "4959750" "4975066" "4997376" "5015207" "5037311" "5071363" "5081563" "5117069" "5123164" "5137456" "5281151" "5309024" "5326936" "5330372" "5334279" "5342999" "5351393" "5371404" "5376825" "5390412").PN.	USPAT	OR	ON	2003/01/06 16:05
S50	2	"5955776".pn.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 16:46
S51	2	"5894173".pn.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 17:35
S52	2	"5877943".pn.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/01/06 17:35
S53	3991	(257/666).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 21:39
S54	0	("20020084516.pn.").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/27 11:27
S55	2	"20020084516".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/27 11:27
S56	24	("3688396" "3852878" "3862790" "4070084" "4543544" "4593243").PN. OR ("4686492"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/27 11:34

S57	4132	(257/666).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/27 11:58
S58	686	S57 and via with lead	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/27 11:35
S59	451	S57 and via with connect\$3 with lead	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/27 11:58
S60	312	S57 and via with connect\$3 with lead	USPAT	OR	ON	2006/06/27 11:41
S61	23	((lead near1 frame lead\$2frame) and (network line bond near2 (pad layer film line)) and (active near2 (device component) transistor gate) and (via damascene plug)).clm.	US-PGPUB	OR	ON	2006/06/27 11:47
S62	1	"6597065".pn.	USPAT	OR	ON	2006/06/27 11:54
S63	8	("4259685" "4346396" "4518982" "5610442" "5753974" "6075289").PN. OR ("6597065"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/27 11:53
S64	1	"6784539".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/27 11:53
S65	2	"6597055".ρn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/27 11:54
S66	2	"6597065".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/27 11:54
S67	1	2004-166422.NRAN.	DERWENT	OR	ON	2006/06/27 11:55
S68	2667	(257/712).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/27 11:58

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	375	(257/672).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/29 10:44
L4	128	2 and via	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/29 10:45

S69	676	(257/781).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/27 11:58
S70	2255	(257/784).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/27 11:58
S71	87	S68 and via with connect\$3 with lead	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/27 11:59
S72	28	S69 and via with connect\$3 with lead	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/27 12:01
S73	180	S70 and via with connect\$3 with lead	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/27 12:02
S74	2418	(257/676).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/27 14:36
S75	89	S74 and lead with over with active	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/27 15:15
S76	440	flores.xa.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/27 15:16
S77	267	delma.xa.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/27 15:16